

LP-1G-TC

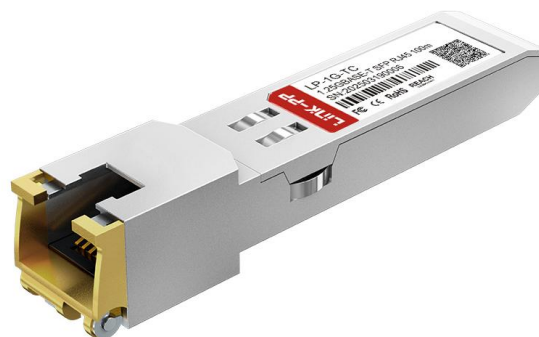
1000BASE-T Copper SFP Transceiver

Features

- Support 1.0Gb/s two-way data transmission link
- Hot-pluggable SFP footprint
- TX Disable and RX Los/without Los function
- Fully metallic enclosure for low EMI
- +3.3V DC single power supply
- Low power dissipation (0.5 W typical)
- Compact RJ-45 connector assembly
- Compatible with IEEE 802.3-2002 and IEEE802.3ab
- Access to physical layer IC via 2-wire serial bus
- 1000 BASE-T operation in host systems with SERDES interface
- Operating case temperature: 0~+70°C

Applications

- 1.0Gigabit Ethernet over Cat 5 cable

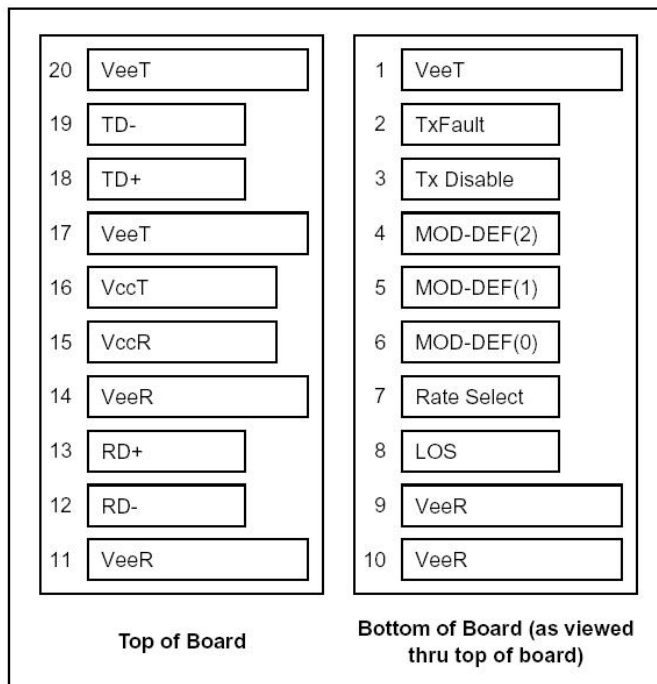


Description

LP-1G-TC Copper Small Form Pluggable (SFP)transceivers is high performance, cost effective module compliant with the Gigabit Ethernet and 1000BASE-T standards as specified in IEEE 802. 3-2002 and IEEE 802.3ab, which supporting 1000Mbps data-rate up to 100 meters reach over unshielded twisted-pair category 5 cable (BER <10⁻¹²). The module supports1000 Mbps full duplex data-links with 5-level Pulse Amplitude Modulation (PAM) signals. The module provides standard serial ID information compliant with SFP MSA, which can be accessed with address of A0h via the 2wire serial CMOS EEPROM protocol. The physical IC can also be accessed via 2wire serial bus at address ACh.

Pin Definitions

Pin Diagram



Pin Descriptions

Pin	Signal Name	Description	Plug Seq.	Notes
1	V _{EET}	Transmitter Ground	1	

2	TX FAULT	Transmitter Fault Indication	3	Note1
3	TX DISABLE	Transmitter Disable	3	Note2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note3
6	MOD_DEF(0)	TTL Low	3	Note3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	V _{EER}	Receiver ground	1	
10	V _{EER}	Receiver ground	1	
11	V _{EER}	Receiver ground	1	
12	RX-	Inv. Received Data Out	3	Note 5
13	RX+	Received Data Out	3	Note 5
14	V _{EER}	Receiver ground	1	
15	V _{CCR}	Receiver Power Supply	2	
16	V _{CCT}	Transmitter Power Supply	2	
17	V _{EET}	Transmitter Ground	1	
18	TX+	Transmit Data In	3	Note 6
19	TX-	Inv. Transmit Data In	3	Note 6
20	V _{EET}	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- TX Fault is an open collector output, which should be pulled up with a 4.7k~10kΩ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a 4.7 ~ 10 K resistor. Its states are:

Low (0 to 0.8V):	Transmitter on
(>0.8, < 2.0V):	Undefined
High (2.0 to 3.465V):	Transmitter Disabled
Open:	Transmitter Disabled
- Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K to 10K resistor on the host board. The pull-up voltage shall be VccT or VccR
 Mod-Def 0 is grounded by the module to indicate that the module is present
 Mod-Def 1 is the clock line of two wire serial interface for serial ID
 Mod-Def 2 is the data line of two wire serial interface for serial ID
- LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a 4.7K to 10K resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to <0.8V.
- RD-/+: These are the differential receiver outputs. They are AC coupled 100 differential lines which should be terminated with 100 (differential) at the user SERDES.
- TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with 100 differential termination inside the module.

Electrical Power Interface

Table 1. +3.3V Volt electrical power interface

+3.3V volt Electrical Power Interface						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Supply Current	Is		320	375	mA	1.2W max power over full range of voltage and temperature. See caution note below
Input Voltage	Vcc	3.13	3.3	3.47	V	Referenced to GND
Maximum Voltage	Vmax			4	V	
Surge Current	Isurge			30	mA	Hot plug above steady state current. See caution note below

Caution: Power consumption and surge current are higher than the specified values in the SFP MSA

Low-Speed Signals

MOD_DEF(1) (SCL) and MOD_DEF(2) (SDA), are open drain CMOS signals (see section VII, "Serial Communication Protocol"). Both MOD_DEF(1) and MOD_DEF(2) must be pulled up to host_Vcc

Table 2. Low-speed signals, electronic characteristics

Low-Speed Signals, Electronic Characteristics					
Parameter	Symbol	Min	Max	Units	Notes/Conditions
SFP Output LOW	VOL	0	0.5	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Output HIGH	VOH	host_Vcc - 0.5	host_Vcc + 0.3	V	4.7k to 10k pull-up to host_Vcc, measured at host side of connector
SFP Input LOW	VIL	0	0.8	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector
SFP Input HIGH	VIH	2	Vcc + 0.3	V	4.7k to 10k pull-up to Vcc, measured at SFP side of connector

High-Speed Electrical Interface

All high-speed signals are AC-coupled internally.

Table 3. High-speed electrical interface, transmission line-SFP

High-Speed Electrical Interface Transmission Line-SFP						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Line Frequency	fL		125		MHz	5-level encoding, per IEEE 802.3

Tx Output Impedance	Zout,TX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz
Rx Input Impedance	Zin,RX		100		Ohm	Differential, for all Frequencies between 1MHz and 125MHz

High-speed electrical interface, host-SFP

Table 4. High-speed electrical interface, host-SFP

High-Speed Electrical Interface, Host-SFP						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Single ended data input swing	Vinsing	250		1200	mV	Single ended
Single ended data output swing	Voutsing	350		800	mV	Single ended
Rise/Fall Time	Tr,Tf		175		psec	20%-80%
Tx Input Impedance	Zin		50		Ohm	Single ended
Rx Output Impedance	Zout		50		Ohm	Single ended

General Specifications

Table 5. General specifications

General						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Data Rate	BR	10		1,000	Mb/sec	IEEE802.3u See Notes 2 through 4 below

Notes:

1. Clock tolerance is +/- 50 ppm

Environmental Specifications

Table 6. Environmental specifications

Environmental Specifications						
Parameter	Symbol	Min	Typ	Max	Units	Notes/Conditions
Operating Temperature	C	0		70	°C	Commercial Case temperature
Storage Temperature	Tsto	-40		85	°C	Ambient temperature

Mechanical Specifications

The host-side of the LP-FE-TCx conforms to the mechanical specifications outlined in the SFP MSA1. The front portion of the SFP (part extending beyond the face plate of the host) is larger to accommodate the RJ-45 connector.

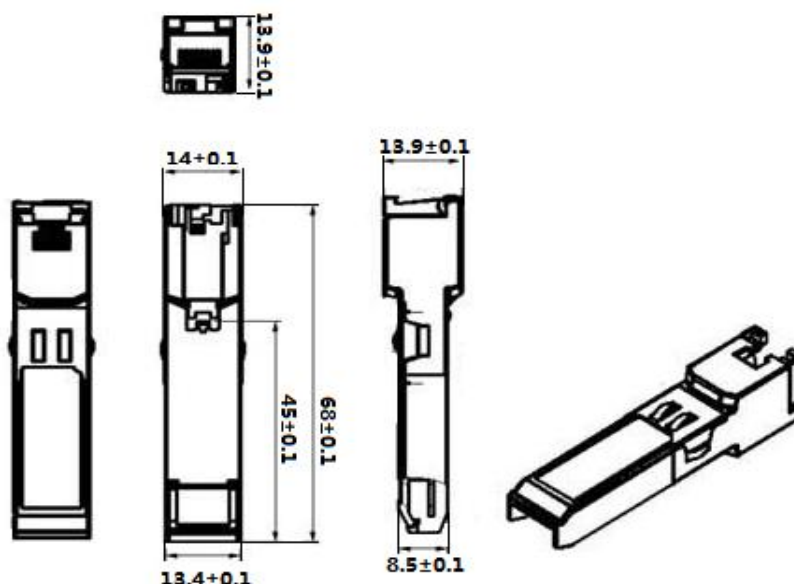


Figure 2. Mechanical dimensions

Ordering information

Part Number	Product Description
LP-1G-TC	1000BASE-T, 0° C~+70° C